



**THE DATASHEET OF  
VS-HFA320NJ40CPBF**

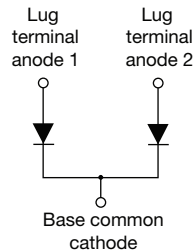


# HEXFRED®

## Ultra Fast Soft Recovery Diode, 320 A



TO-244


**FEATURES**

- Very low  $Q_{rr}$  and  $t_{rr}$
- UL approved file E222165
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT

**BENEFITS**

- Reduced RFI and EMI
- Reduced snubbing

**DESCRIPTION / APPLICATIONS**

HEXFRED® diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and  $di_F/dt$  simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.

**PRIMARY CHARACTERISTICS**

|                       |                           |
|-----------------------|---------------------------|
| $I_{F(AV)}$           | 320 A                     |
| $V_R$                 | 400 V                     |
| $I_{F(DC)}$ at $T_C$  | 255 A at 85 °C            |
| Package               | TO-244                    |
| Circuit configuration | Two diodes common cathode |

**ABSOLUTE MAXIMUM RATINGS**

| PARAMETER  | SYMBOL         | TEST CONDITIONS  | MAX.        | UNITS |
|--|----------------|--|-------------|-------|
| Cathode to anode voltage                         | $V_R$          |  | 400         | V     |
| Continuous forward current                       | $I_F$          | $T_C = 25\text{ °C}$   | 420         | A     |
|  |                | $T_C = 85\text{ °C}$   | 255         |       |
|  |                | $T_C = 115\text{ °C}$  | 160         |       |
| Single pulse forward current                     | $I_{FSM}$      | Limited by junction temperature                              | 1200        |       |
| Non-repetitive avalanche energy                  | $E_{AS}$       | $L = 100\ \mu\text{H}$ , duty cycle limited by maximum $T_J$ | 1.4         | mJ    |
| Maximum power dissipation                        | $P_D$          | $T_C = 25\text{ °C}$   | 625         | W     |
|  |                | $T_C = 100\text{ °C}$  | 250         |       |
| Operating junction and storage temperature range | $T_J, T_{Stg}$ |  | -55 to +150 | °C    |

**ELECTRICAL SPECIFICATIONS ( $T_J = 25\text{ °C}$  unless otherwise specified)**

| PARAMETER                          | SYMBOL   | TEST CONDITIONS                             | MIN.       | TYP. | MAX. | UNITS |
|------------------------------------|----------|---|------------|------|------|-------|
| Cathode to anode breakdown voltage | $V_{BR}$ | $I_R = 100\ \mu\text{A}$                    | 400        | -    | -    | V     |
| Maximum forward voltage            | $V_{FM}$ | $I_F = 160\text{ A}$                        | -          | 1.10 | 1.35 |       |
|                                    |          | $I_F = 320\text{ A}$                        | -          | 1.30 | 1.54 |       |
|                                    |          | $I_F = 160\text{ A}, T_J = 125\text{ °C}$   | -          | 1.00 | 1.20 |       |
| Maximum reverse leakage current    | $I_{RM}$ | $T_J = 125\text{ °C}, V_R = 400\text{ V}$   | See fig. 2 | 0.9  | 3    | mA    |
| Junction capacitance               | $C_T$    | $V_R = 200\text{ V}$                        | See fig. 3 | 370  | 500  | pF    |
| Series inductance                  | $L_S$    | From top of terminal hole to mounting plane | -          | 5.0  | -    | nH    |



| DYNAMIC RECOVERY CHARACTERISTICS (T <sub>J</sub> = 25 °C unless otherwise specified) |                         |   |      |      |      |       |
|--|-------------------------|---|------|------|------|-------|
| PARAMETER  | SYMBOL                  | TEST CONDITIONS   | MIN. | TYP. | MAX. | UNITS |
| Reverse recovery time<br>See fig. 5  | t <sub>rr</sub>         | I <sub>F</sub> = 1.0 A, di <sub>F</sub> /dt = 200 A/μs, V <sub>R</sub> = 30 V | -    | 45   | -    | ns    |
|  |                         | T <sub>J</sub> = 25 °C  | -    | 90   | 140  |       |
|  |                         | T <sub>J</sub> = 125 °C   | -    | 290  | 440  |       |
| Peak recovery current<br>See fig. 6  | I <sub>RRM</sub>        | T <sub>J</sub> = 25 °C  | -    | 8.7  | 20   | A     |
|  |                         | T <sub>J</sub> = 125 °C   | -    | 18   | 30   |       |
| Reverse recovery charge<br>See fig. 7  | Q <sub>rr</sub>         | T <sub>J</sub> = 25 °C  | -    | 420  | 1100 | nC    |
|  |                         | T <sub>J</sub> = 125 °C   | -    | 2600 | 7000 |       |
| Peak rate of recovery current<br>See fig. 8  | di <sub>(rec)</sub> /dt | T <sub>J</sub> = 25 °C  | -    | 300  | -    | A/μs  |
|  |                         | T <sub>J</sub> = 125 °C   | -    | 280  | -    |       |

| THERMAL - MECHANICAL SPECIFICATIONS            |                                   |            |      |          |                     |             |
|--|-----------------------------------|------------|------|----------|---------------------|-------------|
| PARAMETER                                      | SYMBOL                            | MIN.       | TYP. | MAX.     | UNITS               |             |
| Maximum junction and storage temperature range | T <sub>J</sub> , T <sub>Stg</sub> | - 55       | -    | 150      | °C                  |             |
| Thermal resistance, junction to case           | R <sub>thJC</sub>                 | per leg    | -    | -        | 0.19                | °C/W<br>K/W |
|  |                                   | per module | -    | -        | 0.095               |             |
| Typical thermal resistance, case to heatsink   | R <sub>thCS</sub>                 | -          | 0.10 | -        |                     |             |
| Weight   |                                   | -          | 68   | -        | g                   |             |
|  |                                   | -          | 2.4  | -        | oz.                 |             |
| Mounting torque (1)                            | center hole                       | 30 (3.4)   | -    | 40 (4.6) | lbf · in<br>(N · m) |             |
|  |                                   | 12 (1.4)   | -    | 18 (2.1) |                     |             |
| Terminal torque                                |                                   | 30 (3.4)   | -    | 40 (4.6) |                     |             |
| Vertical pull                                  |                                   | -          | -    | 80       | lbf · in            |             |
| 2" lever pull                                  |                                   | -          | -    | 35       |                     |             |

**Note**

(1) Mounting surface must be smooth, flat, free of burrs or other protrusions. Apply a thin even film or thermal grease to mounting surface. Gradually tighten each mounting bolt in 5 to 10 lbf · in steps until desired or maximum torque limits are reached.

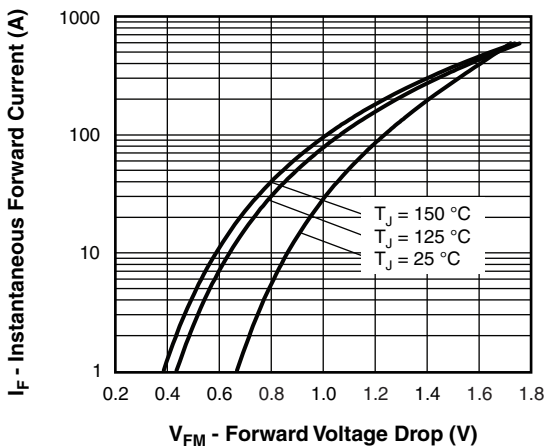


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current (Per Leg)

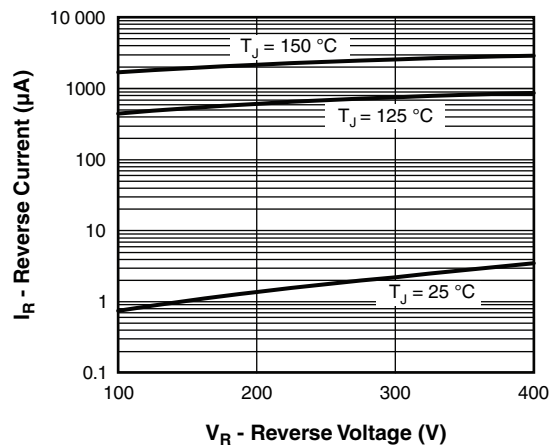


Fig. 2 - Typical Reverse Current vs. Reverse Voltage (Per Leg)

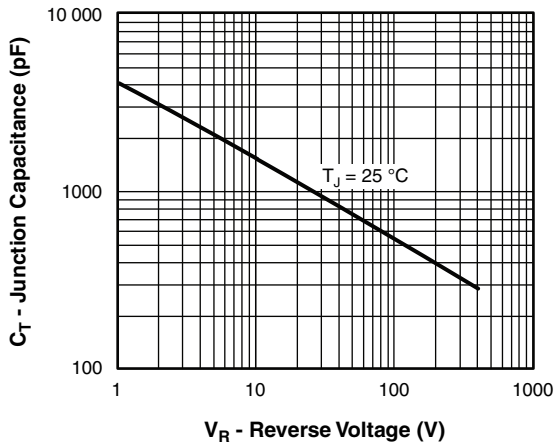


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

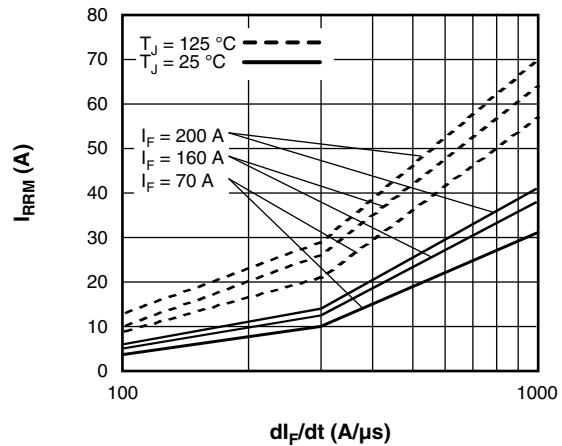


Fig. 6 - Typical Recovery Current vs.  $di_F/dt$  (Per Leg)

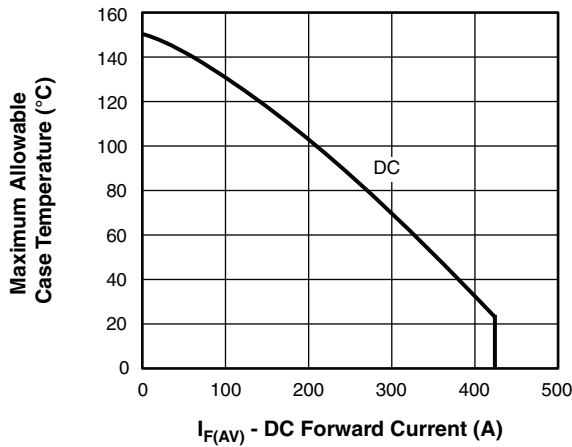


Fig. 4 - Maximum Allowable Case Temperature vs. DC Forward Current (Per Leg)

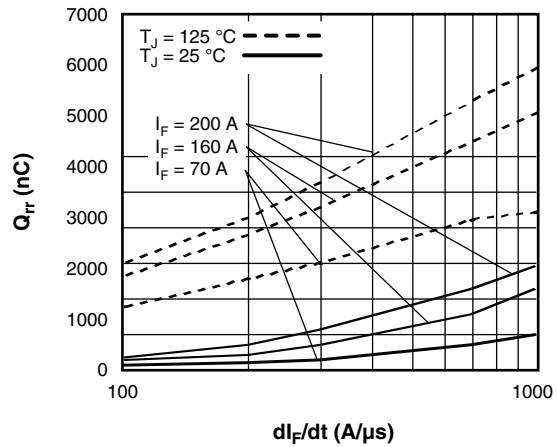


Fig. 7 - Typical Stored Charge vs.  $di_F/dt$  (Per Leg)

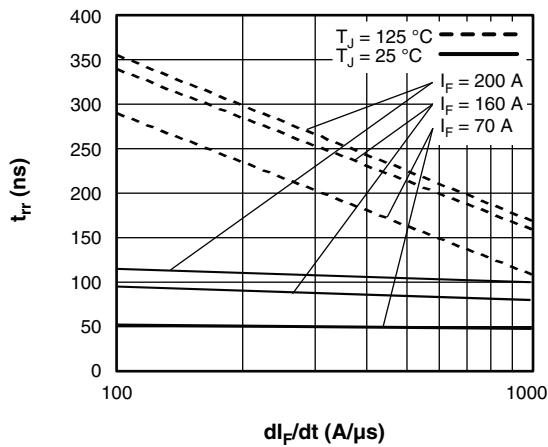


Fig. 5 - Typical Reverse Recovery Time vs.  $di_F/dt$  (Per Leg)

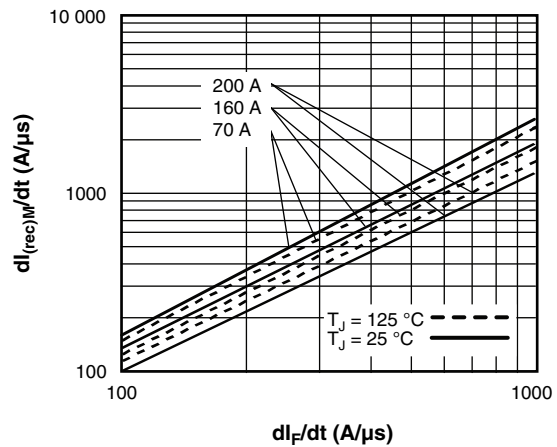


Fig. 8 - Typical  $di_{(rec)M}/dt$  vs.  $di_F/dt$  (Per Leg)

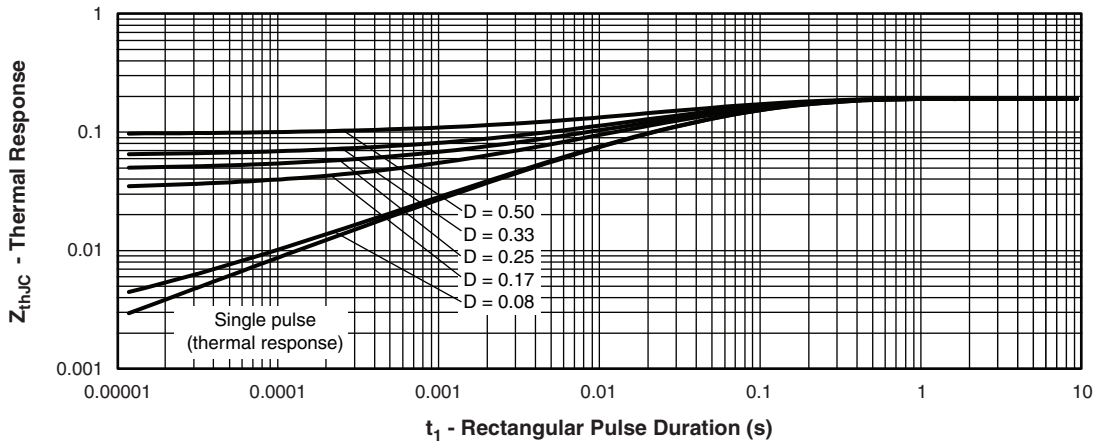


Fig. 9 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics (Per Leg)

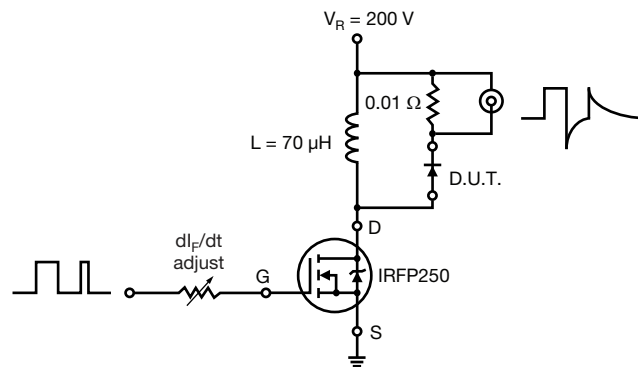
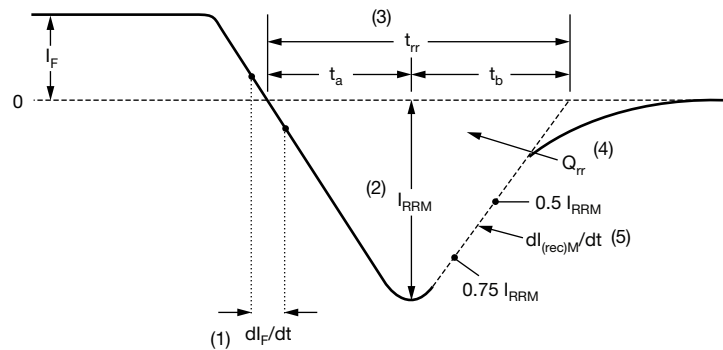


Fig. 10 - Reverse Recovery Parameter Test Circuit



- (1)  $di_F/dt$  - rate of change of current through zero crossing
- (2)  $I_{RRM}$  - peak reverse recovery current
- (3)  $t_{rr}$  - reverse recovery time measured from zero crossing point of negative going  $I_F$  to point where a line passing through  $0.75 I_{RRM}$  and  $0.50 I_{RRM}$  extrapolated to zero current.
- (4)  $Q_{rr}$  - area under curve defined by  $t_{rr}$  and  $I_{RRM}$
- (5)  $di_{(rec)M}/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

Fig. 11 - Reverse Recovery Waveform and Definitions

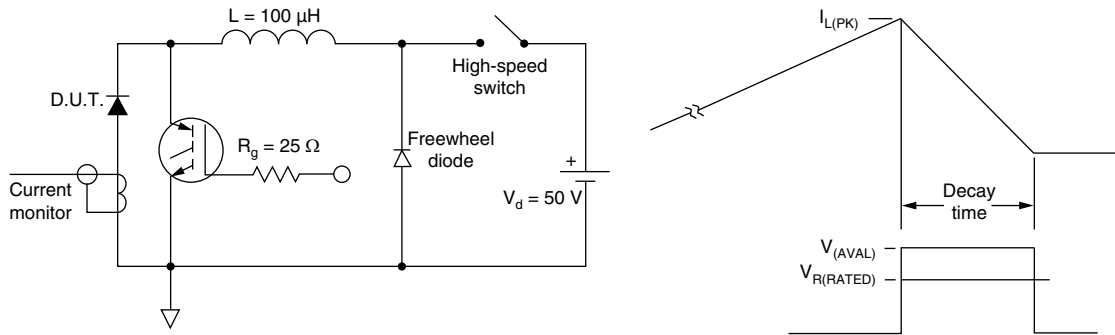


Fig. 12 - Avalanche Test Circuit and Waveforms

**ORDERING INFORMATION TABLE**

|             |            |            |            |           |           |          |            |
|-------------|------------|------------|------------|-----------|-----------|----------|------------|
| Device code | <b>VS-</b> | <b>HFA</b> | <b>320</b> | <b>NJ</b> | <b>40</b> | <b>C</b> | <b>PbF</b> |
|             | ①          | ②          | ③          | ④         | ⑤         | ⑥        | ⑦          |

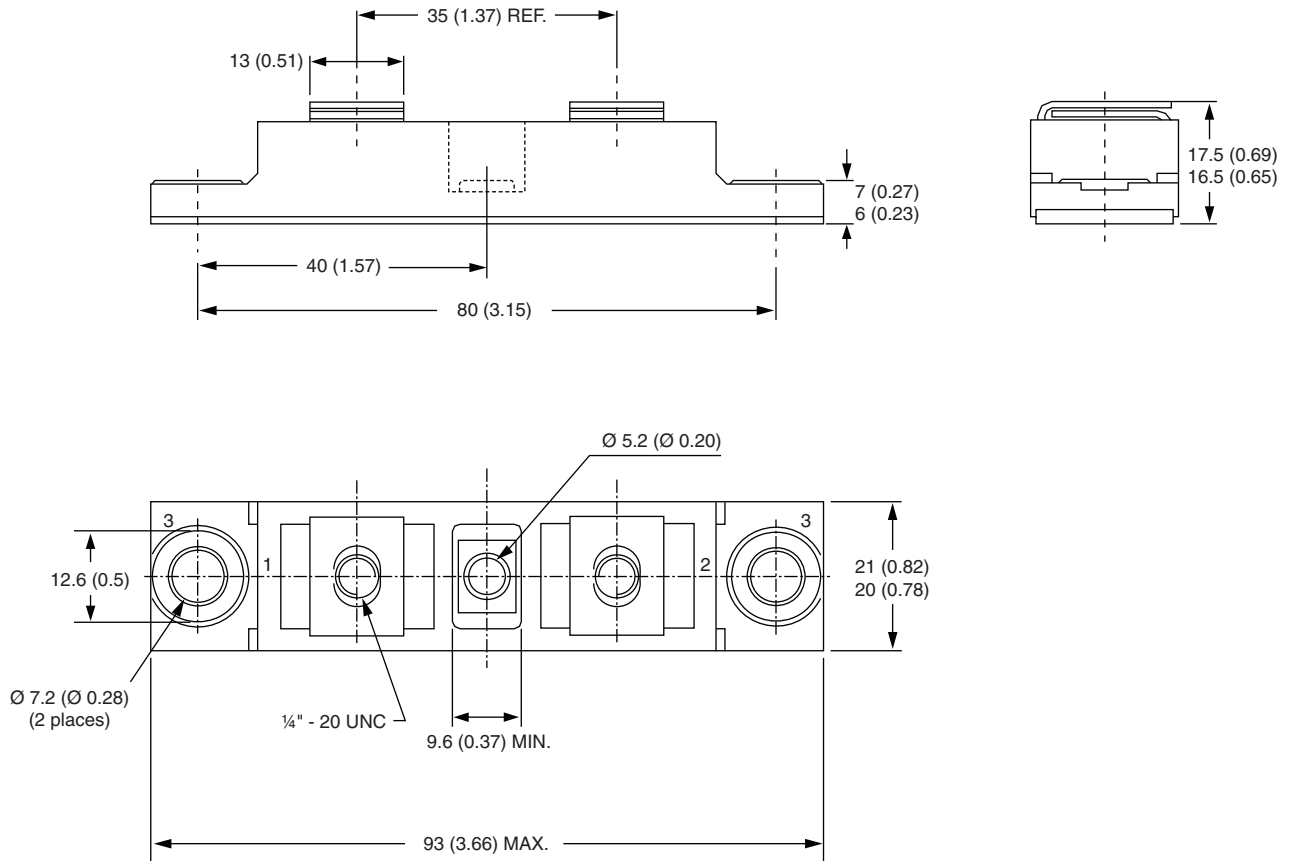
- 1** - Vishay Semiconductors product
- 2** - HEXFRED® family, electron irradiated
- 3** - Average current rating
- 4** - NJ = TO-244
- 5** - Voltage rating (400 V)
- 6** - C = common cathode
- 7** - Lead (Pb)-free

| LINKS TO RELATED DOCUMENTS |  |
|----------------------------|--|
| Dimensions                 | <a href="http://www.vishay.com/doc?95021">www.vishay.com/doc?95021</a> |



## TO-244

**DIMENSIONS** in millimeters (inches)





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